

Halogen Free & RoHs Compliance

SPECIFICATION FOR APPROVAL

CUSTOMER	٠
CUSICINER	٠

CUSTOMER P/N:

OUR DWG No:

QUANTITY :

Pcs. DATE :

2014/06/09

ITEM :

0

MHCD201610A-1R0M-A8L

	SPECIFICATION ACCEPTED BY:	
COMPONENT	ACCELLED DT.	
ENGINEER		
ELECTRICAL		
ENGINEER		
MECHANICAL		
ENGINEER		
APPROVED		
REJECTED		
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奇力新電子(河南)有限公 Chilisin Electronics (Henan) Co XiuWu Xian, industry gathering JiaoZuo, Henan China Postal Code:454350 TEL:+86-391-717-0682 FAX:+86-391-717-0666	area 可刀和电丁(鮴州	Suzhou) Co., Ltd. Rd., Suzhou New District, 350
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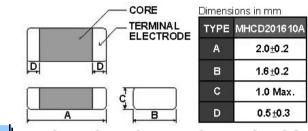
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	ing: Product Identification	nce ons code	
Rating:			
	emperature: -40℃~125℃(Incl emperature: -40℃~125℃(at -5℃~35℃,Humidi		
Storage 1	emperature: −4 0 ℃~1 2 5 ℃(af −5 ℃~3 5 ℃,Humidi	iter PCB)	
Storage T Marking: No Markin	emperature: −4 0 ℃~1 2 5 ℃(af −5 ℃~3 5 ℃,Humidi	iter PCB)	
Storage T Marking: No Markin	'emperature: −40℃~125℃(af −5℃~35℃,Humidi	iter PCB)	
Storage T Marking: No Markin	remperature: -40℃~125℃(af -5℃~35℃,Humidi	fter PCB) ty 4 5 %~ 8 5 % (before	



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6 Configuration and Dimensions:



7 ELECTRICAL CHARACTERISTICS :

Part No.	Inductance (uH)	Test Freq.	Irms(A) Max.(Typ)	lsat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	Tolerance (±%)	
MHCD201610A-1R0M-A8L	. 1	2MHz,0.2V	2.7(3.4)	3.0(3.8)	62(53)	20	

NOTE:

1.Operating temperature range $=4~~0~\mathbb{C} \sim 1~2~5~\mathbb{C}$ (Including self - temperature rise)

2.Irms DC current (A) that will cause an approximate ΔT of 40°C.

3.Isat DC current (A) that will cause Lo to drop approximately 30%

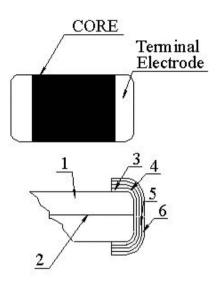
4.All test data is referenced to $25\,^\circ\!\mathrm{C}$ ambient



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8.1 Construction:



8.2 Material List:

NO	Part	Description
1	Core	Metal Power
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



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9 Reliability Of Molding power inductors

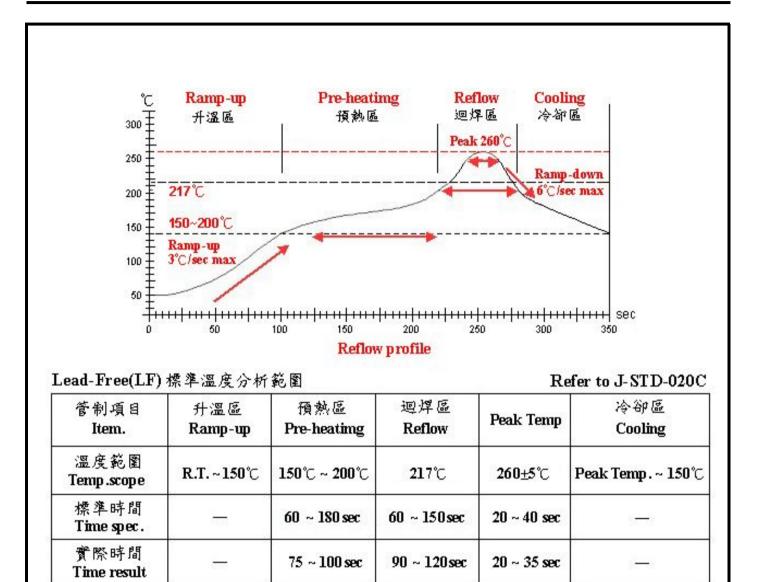
1-1.Mechanical Performance					
ltem	Specification				

	ltem	Specification		Test Method		
1-1-1	Flexure Strength	The forces applied on the right	Test d	evice shall be soldered on the substrate		
		conditions must not damage	Substr	ate Dimension: 100x40x1.6mm		
		the terminal electrode and the	~~~~			
				ng Time: 30sec		
1-1-2	Vibration		Test d	evice shall be soldered on the substrate		
			Oscilla	tion Frequency: 10 to 55 to 10Hz for 1min		
			Amplit	ude: 1.5mm		
			-	2hrs for each axis (X, Y & Z), total 6hrs		
1-1-3	Resistance to Soldering Heat	Appearance: No damage	Pre-heating: 150°C, 1min al Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260±5°C			
			Immersion Time: 10±1sec			
		Inductance: within ±20% of				
		initial value				
1-1-4	Solder ability		Pre-heating: 150℃, 1min			
				Composition: Sn/Ag3.0/Cu0.5(Pb-Free)		
		solder coating	Solder Temperature: 245±5°C			
		-	Immersion Time: 4±1sec			
1-1-5	Terminal Strength Test	No split termination	Test device shall be soldered on the substrate.			
		Chip	then apply a force in the direction of the arrow.			
		Force : 5N		: 5N		
		F	Keepir	ng Time: 10±1sec		
		Mounting Pad		11 //		
	nvironmental Performance					
No	Item	Specification		Test Method		
1-2-1	Temperature Cycle	Annoaranco: No damago	$\cap n \cap n$			
	remperature oyeic		One c			
		Inductance:within±20% of	Step	Temperature (°d)		
			Step 1	Temperature (°d) //Time (min) -40±3 30		
		Inductance:within±20% of	Step 1 2	Temperature (°C) //Time (min) -40±3 30 25±2 2		
		Inductance:within±20% of	Step 1	Temperature (°C) //Time (min) -40±3 30 25±2 2 125±3 30		
		Inductance:within±20% of	Step 1 2 3 4	Temperature (°C) //Time (min) -40±3 30 25±2 2 125±3 30 25±2 2		
		Inductance:within±20% of initial value	Step 1 2 3 4 Total:	Temperature (°C) //Time (min) -40±3 30 25±2 2 125±3 30 25±2 2 100cycles 100		
		Inductance:within±20% of initial value	Step 1 2 3 4 Total: Measu	Temperature (°C) //Time (min) -40±3 30 25±2 2 125±3 30 25±2 2 100cycles 2 ired after exposure in the room condition for 24hrs		
	Humidity Resistance	Inductance:within±20% of initial value	Step 1 2 3 4 Total: Measu Tempe	Temperature (°C) / Time (min) -40±3 30 25±2 2 125±3 30 25±2 2 100cycles 2 ired after exposure in the room condition for 24hrs erature: 60±2°C		
		Inductance:within±20% of initial value	Step 1 2 3 4 Total: Measu Tempe Relativ	Temperature (°C)(°C)-40±330 25 ± 2 2125±33025±22100cycles2irred after exposure in the room condition for 24hrserature: $60\pm2°C$ /e Humidity: 90 ~ 95% / Time: 500hrs.		
1-2-2	Humidity Resistance	Inductance:within±20% of initial value	Step 1 2 3 4 Total: Measu Tempe Relativ	Temperature (°C) / Time (min) -40±3 30 25±2 2 125±3 30 25±2 2 100cycles 2 ired after exposure in the room condition for 24hrs erature: 60±2°C		
1-2-2		Inductance:within±20% of initial value	Step 1 2 3 4 Total: Measu Tempe Relativ Measu Tempe	Temperature (°C)(°C)-40±33025±22125±33025±22100cyclesired after exposure in the room condition for 24hrserature: $60\pm2^{\circ}C$ ve Humidity: 90 ~ 95% / Time: 500hrsired after exposure in the room condition for 12hrserature: $85\pm3^{\circ}C$		
1-2-2	Humidity Resistance	Inductance:within±20% of initial value	Step 1 2 3 4 Total: Measu Tempe Relativ Tempe Relativ	Temperature (°C)(°C)-40±33025±22125±33025±22100cyclesired after exposure in the room condition for 24hrserature: $60\pm2^{\circ}C$ // e Humidity: 90 ~ 95% / Time: 500hrsired after exposure in the room condition for 12hrserature: $85\pm3^{\circ}C$ // e Humidity: 0% / Time: 500hrs		
1-2-2 1-2-3	Humidity Resistance High Temperature Resistance	Inductance:within±20% of initial value	Step 1 2 3 4 Total: Measu Tempe Relativ Tempe Relativ	Temperature (°C)(°C)-40±33025±22125±33025±22100cyclesirred after exposure in the room condition for 24hrserature: $60\pm2^{\circ}C$ ve Humidity: 90 ~ 95% / Time: 500hrsirred after exposure in the room condition for 12hrserature: $85\pm3^{\circ}C$		
1-2-2	Humidity Resistance High Temperature Resistance	Inductance:within±20% of initial value	Step 1 2 3 4 Total: Measu Tempe Relativ Measu Measu Measu	Temperature (°C)(°C)-40±33025±22125±33025±22100cyclesired after exposure in the room condition for 24hrserature: $60\pm2^{\circ}C$ // e Humidity: 90 ~ 95% / Time: 500hrsired after exposure in the room condition for 12hrserature: $85\pm3^{\circ}C$ // e Humidity: 0% / Time: 500hrs		
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NOTE :

1. Re-flow possible times : within 2 times

2. Nitrogen adopted is recommended while in re-flow

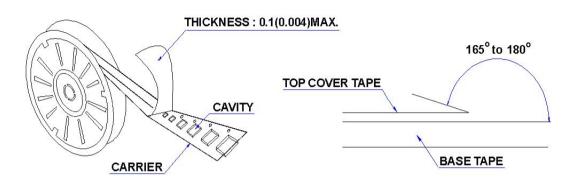


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11 PACKAGING

11.1 Packaging -Cover tape

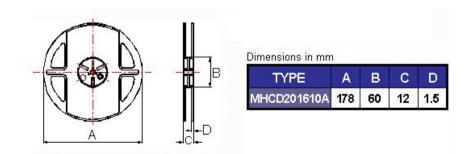
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



11.2 Packaging Quantity

TYPE	BULK	PCS/REEL
MHCD201610A	1	3000

11.3 Reel Dimensions

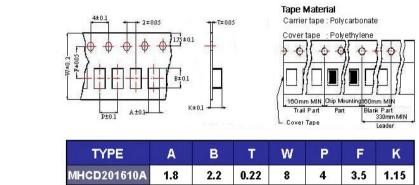




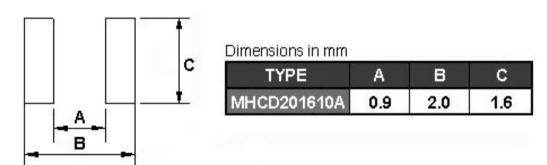
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11 PACKAGING

11.4 Tape Dimensions in mm



12 Recommended Pattern



13 Note:

- 1. Please make sure that your product is has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)